





Features

- ♦ For surface mounted application
- ♦ Metal silicon junction, majority carrier conduction
- ♦ Low forward voltage drop
- High surge current capability
- Plastic material used carries Underwriters Laboratory Classification 94V-0
- ♦ Epitaxial construction
- High temperature soldering:
 260°C / 10 seconds at terminals

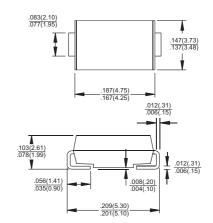
Mechanical Data

- ♦ Cases: Molded plastic
- ♦ Terminals: Matte tin plating
- ♦ Polarity: Indicated by cathode band
- Packaging: 12mm tape per EIA STD RS-481
- ♦ Weight: 0.093 gram

SSL22 - SSL24

2.0 AMP. Surface Mount Low V_F Schottky Barrier Rectifiers

SMB/DO-214AA



Dimensions in inches and (millimeters)

Maximum Ratings and Electrical Characteristics

Rating at 25 °C ambient temperature unless otherwise specified.

Single phase, half wave, 60 Hz, resistive or inductive load.

For capacitive load, derate current by 20%

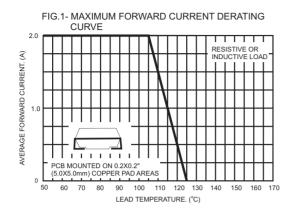
Type Number	Symbol	SSL22	SSL23	SSL24	Units
Maximum Recurrent Peak Reverse Voltage	V_{RRM}	20	30	40	V
Maximum RMS Voltage	V_{RMS}	14	21	28	V
Maximum DC Blocking Voltage	V_{DC}	20	30	40	V
Maximum Average Forward Rectified Current See Fig. 1	I _(AV)	2.0			А
Peak Forward Surge Current, 8.3 ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method)	I _{FSM}	80			А
Maximum Instantaneous Forward Voltage (Note 1) @ 2.0A	V _F	0.41			V
Maximum DC Reverse Current @ T _A =25 °C	I-	0.4			mA
at Rated DC Blocking Voltage @ T _A =100 °C	I _R	50		60	mA
Maximum Thermal Resistance (Note 2)	R _{θJL}	25			°C /W
	R _{0JA}	70			
Marking Code		SL22	SL23	SL24	
Operating Temperature Range	TJ	-55 to +125			°C
Storage Temperature Range	Тѕтс	-55 to + 150			°C

Notes: 1. Pulse Test with PW=300 usec, 1% Duty Cycle.

2. Measured on P.C. Board with 0.4 x .4"(10 x 10mm) Copper Pad Areas.



RATINGS AND CHARACTERISTIC CURVES (SSL22 THRU SSL24)



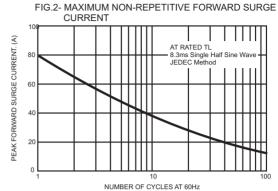


FIG.3- TYPICAL FORWARD CHARACTERISTICS

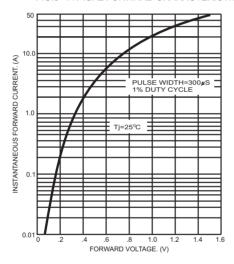


FIG.4- TYPICAL REVERSE CHARACTERISTICS

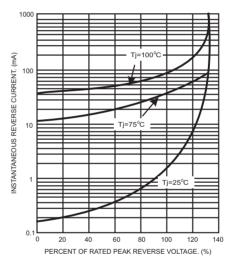


FIG.5- TYPICAL JUNCTION CAPACITANCE

